QUALITY
SEMICONDUCTOR, INC.

High-Speed CMOS 3.3V 16-Bit Buffers/Line Drivers

QS74LVC16244A

FEATURES/BENEFITS

- 5V tolerant inputs and outputs
- 10µA I_{CCQ} quiescent power supply current
- Hot insertable
- 2.0V–3.6V V_{CC} supply operation
- ±24mA balanced output drive
- Power down high impedance inputs and outputs
- t_{PD} = 4.1ns max.
- Input hysteresis for noise immunity
- Meets or exceeds JEDEC Standard 36 specifications
- Multiple power and ground pins for low noise
- Operating temperature range:
  –40°C to 85°C
- Latch-up performance exceeds 500mA
- ESD performance:
  Human body model > 2000V
  Machine model > 200V
- Packages available:
  48-pin TSSOP
  48-pin SSOP

DESCRIPTION

The QS74LVC16244A is a 16-bit bus interface buffer with three-state output that is ideal for driving address, clocks, and data buses. Output enables are used to enable or disable Y ports by placing them in a high impedance condition. The 3.3V LVC family features low power, low switching noise, and fast switching speeds for low power portable applications as well as high-end, advanced workstation applications. 5V tolerant inputs and outputs allow these LVC products to be used in mixed 5V and 3.3V applications. Easy board layout is facilitated by the use of flow-through pinouts and byte enable controls provide architectural flexibility for systems designers. To accommodate hot-plug or live insertion applications, this product is designed not to load an active bus when V_{CC} is removed. However, during power up or power down sequence, $\overline{OE}$ should be tied to V_{CC} to ensure high-impedance state on the outputs.

Figure 1. Functional Block Diagram

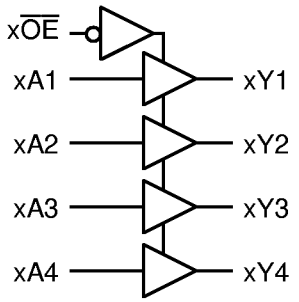


Figure 2. Pin Configuration
(All Pins Top View)

SSOP, TSSOP

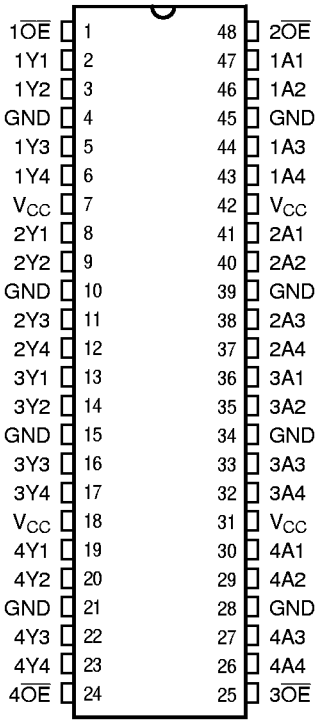


Table 1. Pin Description

Name	Description
x$\overline{OE}$	Three-State Output Enable Inputs
xAx	Data Inputs (Bus Hold)
xYx	Three-State Outputs

Table 2. Function Table

Inputs		Outputs
x$\overline{OE}$	xAx	xYx
L	L	L
L	H	H
H	X	Hi-Z

Table 3. Absolute Maximum Ratings

Supply Voltage to Ground	–0.5V to 7.0V
DC Output Voltage V_{OUT}	
Outputs HIGH-Z	–0.5V to 7.0V
Outputs Active	–0.5V to V_{CC} + 0.5V
DC Input Voltage V_{IN}	–0.5V to 7.0V
DC Input Diode Current with $V_{IN} < 0$	–50mA
DC Output Diode Current	
$V_O < 0$	–50mA
$V_O > V_{CC}$	50mA
DC Output Source/Sink Current (I_{OH}/I_{OL})	±50mA
DC Supply Current per Supply Pin	±100mA
DC Ground Current per Ground Pin	±100mA
T_{STG} Storage Temperature	–65°C to 150°C

Note: Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to this device resulting in functional or reliability type failures.

Table 4. Recommended Operating Conditions

Symbol	Parameter		Min	Max	Unit
V_{CC}	Supply Voltage, Operating		2.0	3.6	V
	Supply Voltage, Data Retention Only		1.5	3.6	
V_{IH}	Input HIGH Voltage	V_{OL} = 2.7 to 3.6V	2.0	—	V
V_{IL}	Input LOW Voltage	V_{CC} = 2.7 to 3.6V	—	0.8	V
V_{IN}	Input Voltage		0	5.5	V
V_{OUT}	Output Voltage in Active State		0	V_{CC}	V
	Output Voltage in "OFF" State		0	5.5	
I_{OH}	Output Current HIGH	V_{CC} = 3.0–3.6V	—	–24	mA
		V_{CC} = 2.7V		–12	
I_{OL}	Output Current LOW	V_{CC} = 3.0–3.6V	—	24	mA
		V_{CC} = 2.7V	—	12	
$\Delta t/\Delta v$	Input Transition Slew Rate		—	10	ns/V
T_A	Operating Free Air Temperature		–40	85	°C

Table 5. DC Electrical Characteristics Over Operating Range

Industrial Temperature Range, T_A = –40°C to 85°C

Symbol	Parameter	Test Conditions	Min	Typ(1)	Max	Unit
V_{OH}	Output HIGH Voltage	V_{CC} = 2.7V, I_{OH} = –100µA V_{CC} = 2.7V, I_{OH} = –12mA V_{CC} = 3.0V, I_{OH} = –12mA V_{CC} = 3.0V, I_{OH} = –24mA	V_{CC} –0.2 2.2 2.4 2.2	— — — —	— — — —	V
V_{OL}	Output LOW Voltage	V_{CC} = 2.7V, I_{OL} = 100µA V_{CC} = 2.7V, I_{OL} =12mA V_{CC} = 3.0V, I_{OL} = 24mA	— — —	— — —	0.2 0.4 0.55	V
V_{IK}	Input Clamp Voltage	V_{CC} = 2.7V, I_{IN} = –18mA	—	–0.7	–1.2	V
I_I	Input Leakage Current	V_I = 0V, V_I = 5.5V, V_{CC} = 3.6V	—	—	±1.0	µA
I_{OZ}	High-Z I/O Leakage	V_O = 0V, V_O = 5.5V, V_I = V_{IH} or V_{IL}, V_{CC} = 3.6V	—	—	±1.0	µA
I_{OFF}	Power Off Leakage	V_{CC} = 0V, V_I or V_O = 5.5V	—	—	10	µA
I_{CC}	Quiescent Power Supply Current	V_{CC} = 3.6V, V_{IN} = V_{CC} or GND	—	0.1	10	µA
ΔI_{CC}	Quiescent Power Supply Current per Inputs at TTL HIGH	V_{CC} = 3.6V, V_{IN} = V_{CC} – 0.6V(2)	—	2.0	3.0	µA

Notes:
1. Typical values are at V_{CC} = 3.3V and T_A = 25°C.
2. Per TTL driven input. All other inputs at V_{CC} or GND.

Table 6. Dynamic Switching Characteristics

Symbol	Parameter	Test Conditions		Typ(1)	Unit
V_{OLP}	Quiet Output Dynamic Peak V_{OL}	C_L = 50pF, V_{CC} = 3.3V	V_{IH} = 3.3V, V_{IL} = 0V	0.8	V
V_{OLV}	Quiet Output Dynamic Valley V_{OL}	C_L = 50pF, V_{CC} = 3.3V	V_{IH} = 3.3V, V_{IL} = 0V	0.8	V
C_{PD}	Power Dissipation	C_L = 50pF, f = 10MHz,	Output Enable	20	pF
		V_{CC} = 3.3 ±0.3V	Output Disable	4	

Note:
1. Typical values are at V_{CC} = 3.3V, 25°C ambient.

Table 7. Capacitance(1)

Symbol	Pins	Conditions	Typ	Unit
C_{IN}	Input Capacitance	V_{IN} = 0V, V_{OUT} = 0V, f = 1MHz	7.0	pF
$C_{I/O}$	I/O Capacitance	V_{IN} = 0V, V_{OUT} = 0V, f = 1MHz	8.0	pF

Note:
1. Capacitance is characterized but not production tested.

Table 8. Switching Characteristics Over Operating Range

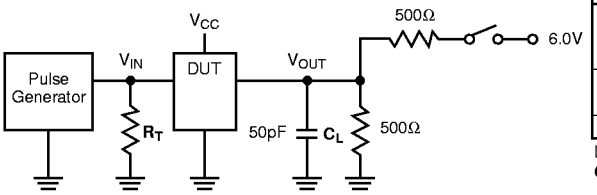
Industrial Temperature Range, T_A = –40°C to 85°C.
C_{LOAD} = 50pF, R_{LOAD} = 500Ω unless otherwise noted.

		V_{CC} = 3.3 ±0.3V		V_{CC} = 2.7V(2)		
Symbol	Description(1)	Min	Max	Min	Max	Unit
t_{PD}	Propagation Delay xAx to xYx	1.5	4.1	1.5	4.7	ns
t_{EN}	Output Enable Time x$\overline{OE}$ to xYx	1.5	4.6	1.5	5.8	ns
t_{DIS}	Output Disable Time(2) x$\overline{OE}$ to xYx	1.5	5.8	1.5	6.2	ns
$t_{SK(O)}$	Output Skew(3)	—	0.5	—	—	ns

Notes:
1. Minimums guaranteed but not tested. See Test Circuit and Waveforms.
2. Guaranteed by characterization.
3. Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by characterization but not production tested.

TEST CIRCUIT AND WAVEFORMS

Figure 3. Test Circuit



SWITCH POSITION

Test	Switch
Open Drain Disable LOW Enable LOW	6V
Disable HIGH Enable HIGH	GND
All Other Inputs	Open

DEFINITIONS:
C_L = Load capacitance: includes jig and probe capacitance.
R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

Figure 4. Setup, Hold, and Release Timing

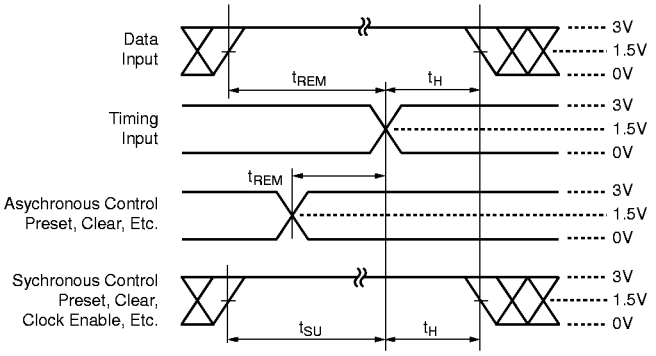
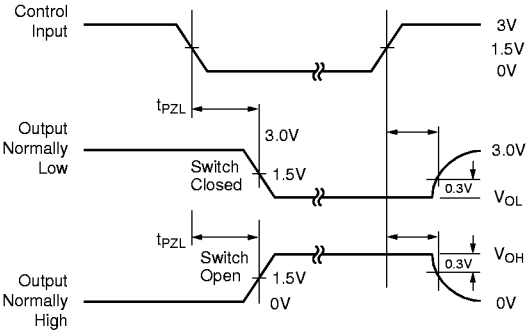


Figure 5. Enable and Disable Timing



Notes:
1. Input Control Enable = LOW and Input Control Disable = HIGH.
2. Pulse Generator for All Pulses: Rate ≤ 1.0MHz; Z_{OUT} ≤ 50Ω; t_F, t_R ≤ 2.5ns.

Figure 6. Pulse Width

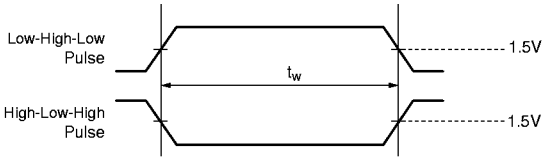
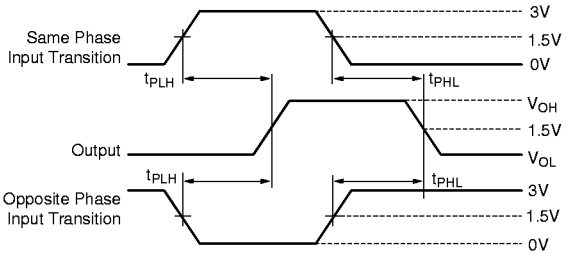
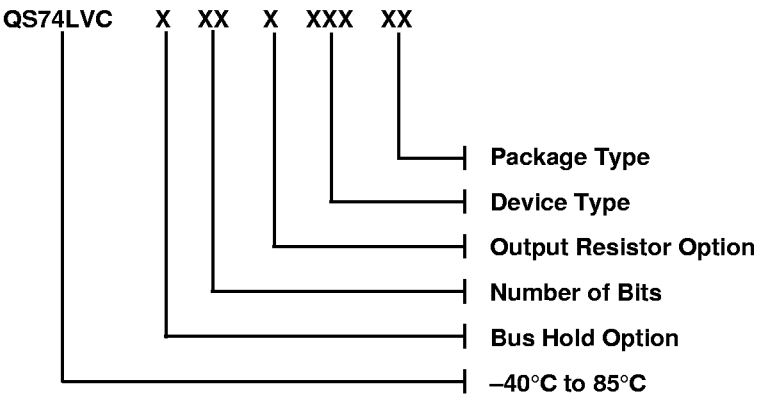


Figure 7. Propagation Delay



ORDERING INFORMATION



Bus Hold Option:
Blank – No Bus Hold

Number of Bits:
16 – 16-Bit

Output Resistor Option:
Blank – No Output Resistor

Device Type:
244

Package Type:
PV – SSOP, 300 mil
PA – TSSOP, 240 mil